February 2000

FDG311N N-Channel 2.5V Specified PowerTrench[®] MOSFET

General Description

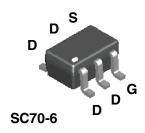
This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench process that has been especially tailored to minimize the on-state resistance and yet maintain low gate charge for superior switching performance. These devices are well suited for portable electronics applications.

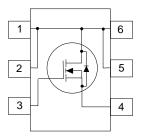
Applications

- Load switch
- Power management
- DC/DC converter

Features

- 1.9 A, 20 V. $R_{DS(ON)} = 0.115 \ \Omega \ @ V_{GS} = 4.5 \ V$ $R_{DS(ON)} = 0.150 \ \Omega \ @ V_{GS} = 2.5 \ V.$
- Low gate charge (3nC typical).
- High performance trench technology for extremely low $R_{DS(ON)}$.
- Compact industry standard SC70-6 surface mount package.





Absolute Maximum Ratings T_A = 25 C unless otherwise noted

Symbol	Parameter			Ratings	Units	
V _{DSS}	Drain-Source Voltage			20	V	
V _{GSS}	Gate-Source Voltage			±8	V	
ID	Drain Current	- Continuous	(Note 1a)	1.9	А	
		- Pulsed		6		
PD	Power Dissipation for Single Operation		(Note 1a)	0.75	W	
			(Note 1b)	0.48		
	Operating and Storage Junction Temperature Range					
T _J , T _{stg}			ure Range	-55 to +150	°C	
	al Character			-55 to +150 260	°C/W	
Therma R _{eJA}	Al Character	istics	(Note 1b)			
Therma R _{aJA} Packag	Al Character	istics ance, Junction-to-Ambient	(Note 1b)			

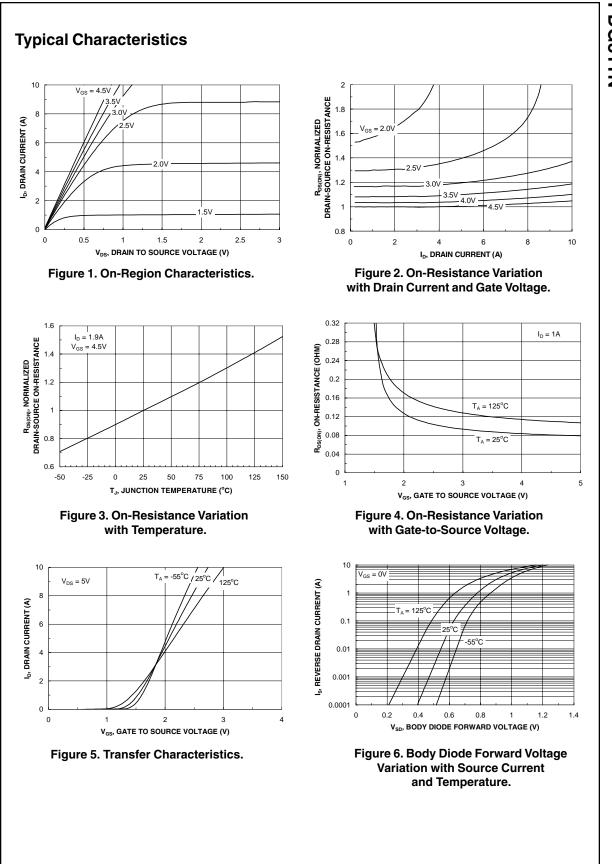
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Cteristics Drain-Source Breakdown Voltage Breakdown Voltage Temperature Coefficient Zero Gate Voltage Drain Current	V_{GS} = 0 V, I_D = 250 µA I_D = 250 µA, Referenced to 25°C	20			V
Drain-Source Breakdown Voltage Breakdown Voltage Temperature Coefficient		20			V
Coefficient	I_D = 250 µA, Referenced to 25°C				I V
Zero Gate Voltage Drain Current			14		mV/°C
Jano Tonago Diani Ganoni	$V_{DS} = 16 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			1	μA
Gate-Body Leakage Forward	$V_{GS} = 8 V, V_{DS} = 0 V$			100	nA
Gate-Body Leakage Reverse	V_{GS} = -8 V, V_{DS} = 0 V			-100	nA
cteristics (Note 2)					
Gate Threshold Voltage	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	0.4	0.9	1.5	V
Gate Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$, Referenced to 25°C		-3		mV/°0
Static Drain-Source On-Resistance	$V_{GS} = 4.5 V, I_D = 1.9 A$ $V_{GS} = 4.5 V, I_D = 1.9 A,$ $T_J = 125^{\circ}C$ $V_{CS} = 2.5 V, I_D = 1.6 A$		0.082 0.110 0.105	0.115 0.170 0.150	Ω
On-State Drain Current	$V_{GS} = 4.5 \text{ V}, V_{DS} = 5 \text{ V}$	4			A
Forward Transconductance	$V_{DS} = 5 \text{ V}, \text{ I}_{D} = 0.5 \text{ A}$		6		S
Characteristics					
Input Capacitance	$V_{DS} = 10 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$		270		pF
Output Capacitance	f = 1.0 MHz		55		pF
Reverse Transfer Capacitance	-		20		pF
Characteristics (Note 2)					
Turn-On Delay Time $V_{DD} = 10 \text{ V}, \text{ I}_D = 1 \text{ A},$			5	12	ns
Turn-On Rise Time	$V_{GS} = 5 V, R_{GEN} = 6 \Omega$		9	17	ns
Turn-Off Delay Time	1		10	18	ns
Turn-Off Fall Time	1		2	6	ns
Total Gate Charge	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 1.9 \text{ A},$		3	4.5	nC
Gate-Source Charge	$V_{GS} = 4.5 V$		0.6		nC
Gate-Drain Charge			0.9		nC
rce Diode Characteristics	and Maximum Ratings				
				0.42	A
Drain-Source Diode Forward	$V_{GS} = 0 V, I_S = 0.42 A$ (Note 2)		0.7	1.2	V
	Gate Threshold Voltage Gate Threshold Voltage Temperature Coefficient Static Drain-Source On-Resistance On-State Drain Current Forward Transconductance Characteristics Input Capacitance Output Capacitance Characteristics (Note 2) Turn-On Delay Time Turn-Off Delay Time Turn-Off Fall Time Total Gate Charge Gate-Source Charge Gate-Drain Charge Tree Diode Characteristics a Maximum Continuous Drain-Source Drain-Source Diode Forward	teristics (Note 2)Gate Threshold Voltage $V_{DS} = V_{GS}$, $I_D = 250 \ \mu$ AGate Threshold Voltage $I_D = 250 \ \mu$ A, Referenced to 25° CTemperature Coefficient $I_D = 250 \ \mu$ A, Referenced to 25° CStatic Drain-Source $V_{GS} = 4.5 \ V$, $I_D = 1.9 \ A$, $T_J = 125^{\circ}$ COn-Resistance $V_{GS} = 4.5 \ V$, $I_D = 1.9 \ A$, $T_J = 125^{\circ}$ COn-State Drain Current $V_{GS} = 4.5 \ V$, $V_{DS} = 5 \ V$ Forward Transconductance $V_{DS} = 5 \ V$, $I_D = 0.5 \ A$ Characteristics nput Capacitance $V_{DS} = 10 \ V$, $V_{GS} = 0 \ V$, f = 1.0 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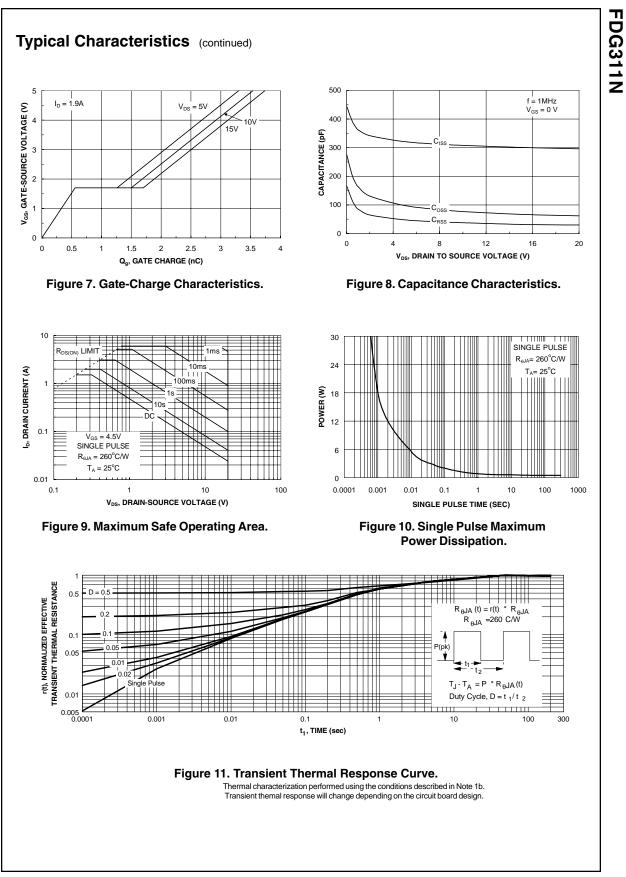
2. Pulse Test: Pulse Width $\leq\!300\,\mu\text{s},$ Duty Cycle $\leq\!2.0\%$

FDG311N Rev. D

FDG311N



FDG311N



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